

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
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Assignment ID: TM1209020

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	SUPPLEMENT NO. 1 TO INTELLECTUAL PROPERTY SECURITY AGREEMENT		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
HYPR CORP.		05/02/2024	Corporation: DELAWARE
RECEIVING PARTY DATA			
Company Name:	JPMorgan Chase Bank, N.A.		
Street Address:	1116 W. Long lake Road		
City:	Bloomfield Hills		
State/Country:	MICHIGAN		
Postal Code:	48302		
Entity Type:	National Banking Association: UNITED STATES		
PROPERTY NUMBERS Total: 9			
Property Type	Number	Word Mark	
Registration Number:	6132303	ADVANCED DEVICE PROTECTION	
Registration Number:	5830110	TRUE PASSWORDLESS SECURITY	
Registration Number:	6079467	ELIMINATE THE TARGET	
Registration Number:	7070855	HYPR	
Registration Number:	6450740	REMOTE LOCK	
Registration Number:	6897244	DECENTRALIZED PIN	
Registration Number:	6578166	THE PASSWORDLESS COMPANY	
Serial Number:	97699388	HYPR SPEED	
Serial Number:	98266925	HYPR	
CORRESPONDENCE DATA			
Fax Number:			
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
Phone:	(800)221-0102		
Email:	ipteam@cogencyglobal.com		
Correspondent Name:	Khadijah Sampson		
Address Line 1:	1025 Connecticut Ave NW, Suite 712		
Address Line 2:	COGENCY GLOBAL INC.		
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20036		

OP \$240.00.00 88701344

ATTORNEY DOCKET NUMBER:	2361088ks
NAME OF SUBMITTER:	Andrew Hackett
SIGNATURE:	Andrew Hackett
DATE SIGNED:	05/03/2024

Total Attachments: 4

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SUPPLEMENT NO. 1 TO INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Supplement No. 1 to Intellectual Property Security Agreement (this “*Supplement No. 1*”) is made as of the 2nd day of May, 2024, by **HYPR CORP.**, a Delaware corporation (the “*Grantor*”), in favor of **JPMORGAN CHASE BANK, N.A.** (“*Lender*”).

WHEREAS, the Grantor executed and delivered an Intellectual Property Security Agreement dated as of April 18, 2023 (as amended and of record from time to time hereinafter, the “*Agreement*”) in favor of the Lender, pursuant to which the Grantor granted a security interest in certain Copyrights, Trademarks, Patents and Mask Works (collectively, the “*Intellectual Property Collateral*”). Capitalized terms not otherwise defined herein shall have the meaning set forth in the Agreement;

WHEREAS, the Agreement was recorded on April 18, 2023 at Reel 063360, Frame 0644 in the Patent division of the U.S. Patent and Trademark Office;

WHEREAS the Grantor desires to confirm the grant of a security interest in certain additional Intellectual Property Collateral in favor of the Lender.

NOW, THEREFORE, in consideration of the mutual covenants herein contained and benefits to be derived herefrom, it is hereby agreed as follows:

1. Definitions. All capitalized terms herein and not otherwise defined shall have the same meaning herein as in the Agreement.
2. Supplement to Patent Exhibit B. Patent Exhibit B to the Agreement is hereby supplemented, but not replaced, by Patent Exhibit B-1 annexed hereto.
3. Supplement to Trademark Exhibit C. Trademark Exhibit C to the Agreement is hereby supplemented, but not replaced, by Trademark Exhibit C-1 annexed hereto.
4. Miscellaneous:
 - a. Except as provided herein, all terms and conditions of the Agreement remain in full force and effect.
 - b. This Supplement covers the entire understanding of the parties with respect to the matters set forth herein and supersedes all prior discussions and negotiations hereon.

[signature pages follow]

IN WITNESS WHEREOF, the undersigned has executed this Supplement as of the date first written above.

GRANTOR:

HYPR CORP.

DocuSigned by:
Roman Kadinsky
By: 1D35483B4EA8495...
Name: Roman Kadinsky
Title: President & COO

EXHIBIT B-1

Patents

Title	Application No.	Filing Date	Patent No.	Issue Date
SECURE MOBILE INITIATED AUTHENTICATIONS TO WEB-SERVICES	18304281	04/20/2023	-	-
MOBILE AUTHENTICATOR FOR PERFORMING A ROLE IN USER AUTHENTICATION	17871770	07/22/2022	11677547	06/13/2023
FEDERATED IDENTITY MANAGEMENT WITH DECENTRALIZED COMPUTING PLATFORMS	17992900	11/22/2022		
MOBILE AUTHENTICATOR FOR PERFORMING A ROLE IN USER AUTHENTICATION	18310880	05/02/2023		
OUT-OF-BAND AUTHENTICATION TO ACCESS WEB-SERVICE WITH INDICATION OF PHYSICAL ACCESS TO CLIENT DEVICE	18191399	03/28/2023		
DOMAIN UNRESTRICTED MOBILE INITIATED LOGIN	17558414	12/21/2021		

EXHIBIT C-1

Trademarks

Mark	Serial No.	Filing Date	Registration No.	Registration Date
ADVANCED DEVICE PROTECTION	88701344	11/21/2019	6132303	08/18/2020
HYPRSPEED	97699388	12/01/2022	-	-
TRUE PASSWORDLESS SECURITY	88062888	08/02/2018	5830110	08/06/2019
ELIMINATE THE TARGET	88694085	11/15/2019	6079467	06/16/2020
HYPR	88205560	11/26/2018	7070855	06/06/2023
REMOTE LOCK	90318749	11/13/2020	6450740	08/10/2021
DECENTRALIZED PIN	90014297	06/22/2020	6897244	11/08/2022
HYPR	98266925	11/13/2023	-	-
THE PASSWORDLESS COMPANY	88834446	03/13/2020	6578166	11/30/2021